

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Engineering Advancement Association of Japan	11/26/2007
RECEIVING PARTY DATA	
Name:	Technova Inc.
Street Address:	1-1, Uchisaiwaicho 1-chome
Internal Address:	13th Floor, The Imperial Hotel Tower
City:	Chiyoda-ku, Tokyo
State/Country:	JAPAN
Postal Code:	100-0011
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	6172294
CORRESPONDENCE DATA	
Fax Number:	(202)628-8844
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	202-624-2500
Email:	afield@crowell.com
Correspondent Name:	Crowell & Moring LLP
Address Line 1:	P.O. Box 14300
Address Line 4:	Washington, DISTRICT OF COLUMBIA 20044-4300
ATTORNEY DOCKET NUMBER:	037140.43676DV
NAME OF SUBMITTER:	Jeffrey D. Sanok, Reg. No. 32,169
Total Attachments: 1 source=6172294_assign#page1.tif	

OP \$40.00 6172294

**ASSIGNMENT**

*Engineering Advancement Association of Japan* [hereinafter "Assignor"] is a partial owner of record of U.S. Patent No. 6,172,294, issued January 9, 2001, and entitled *Thermoelectric Semiconductor having a Sintered Semiconductor Layer and Fabrication Process Thereof* by virtue of an assignment recorded in the U.S. Patent and Trademark Office; and

WHEREAS, *Technova Inc.* [hereinafter "Assignee"], of 13<sup>th</sup> Floor, The Imperial Hotel Tower, 1-1, Uchisaiwaicho 1-chome, Chiyoda-ku, Tokyo 100-0011, Japan, is desirous of acquiring Assignor's share of the entire right, title, and interest in and to the said invention and in and to the said Letters Patent;

NOW, THEREFOR, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, Assignor does hereby convey, assign and transfer to Assignee, its successors and assigns, its share of the entire right, title and interest in and to the said Letters Patent, and all the rights, powers, liberties and immunities conferred on the owner by the grant of the resulting Patent, including rights to sue for damages and other remedies in respect of any infringement of the Patent, which may have occurred prior to the date hereof, and the right to recover for all past infringement; and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and Assignor hereby authorizes and requests the Commissioner of Patents and Trademarks to issue all patents for said invention, or patents resulting therefrom, insofar as its interest is concerned, to Assignee, its successors and assigns.

IN WITNESS WHEREOF, Assignor has caused this Assignment to be duly executed by its authorized representative on the date set forth below.

**ENGINEERING ADVANCEMENT ASSOCIATION OF JAPAN**

By: *N. Masuda*

Printed Name: Nobuyuki MASUDA

Title: Chairman

Date: 11/26/2007